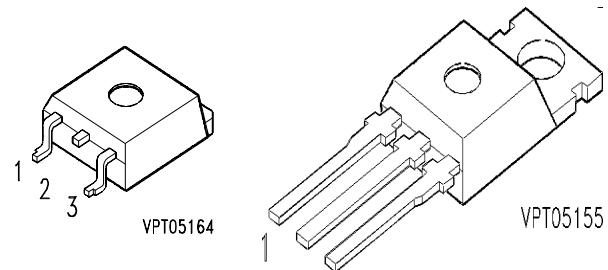


SIPMOS® Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated
- dv/dt rated
- 175°C operating temperature
- also in SMD available



Pin 1	Pin 2	Pin 3
G	D	S

Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Ordering Code
BUZ 103 S	55 V	31 A	0.04 Ω	TO-220 AB	Q67040-S4009-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current $T_C = 25^\circ\text{C}$	I_D	31	A
$T_C = 100^\circ\text{C}$		22	
Pulsed drain current $T_C = 25^\circ\text{C}$	$I_{D\text{puls}}$	124	
Avalanche energy, single pulse $I_D = 31 \text{ A}, V_{DD} = 25 \text{ V}, R_{GS} = 25 \Omega$ $L = 291 \mu\text{H}, T_j = 25^\circ\text{C}$	E_{AS}	140	mJ
Avalanche current, limited by $T_{j\text{max}}$	I_{AR}	31	A
Avalanche energy, periodic limited by $T_{j\text{max}}$	E_{AR}	7.5	mJ
Reverse diode dv/dt $I_S = 31 \text{ A}, V_{DS} = 40 \text{ V}, di_F/dt = 200 \text{ A}/\mu\text{s}$ $T_{j\text{max}} = 175^\circ\text{C}$	dv/dt	6	kV/μs
Gate source voltage	V_{GS}	± 20	V
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	75	W

Maximum Ratings

Parameter	Symbol	Values	Unit
Operating temperature	T_j	-55 ... + 175	°C
Storage temperature	T_{stg}	-55 ... + 175	
Thermal resistance, junction - case	R_{thJC}	≤ 2	K/W
Thermal resistance, junction - ambient	R_{thJA}	≤ 62	
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}$, $I_D = 0.25 \text{ mA}$, $T_j = 25^\circ\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}$, $I_D = 50 \mu\text{A}$	$V_{GS(\text{th})}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = -40^\circ\text{C}$	I_{DSS}	-	-	0.1	μA
$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 25^\circ\text{C}$		-	0.1	1	
$V_{DS} = 50 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_j = 150^\circ\text{C}$		-	-	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}$, $V_{DS} = 0 \text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 10 \text{ V}$, $I_D = 22 \text{ A}$	$R_{DS(\text{on})}$	-	0.03	0.04	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 22 \text{ A}$	g_{fs}	10	-	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	720	900	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	230	300	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	125	160	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 31 \text{ A}$ $R_G = 13 \Omega$	$t_{d(on)}$	-	10	15	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 31 \text{ A}$ $R_G = 13 \Omega$	t_r	-	25	40	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 31 \text{ A}$ $R_G = 13 \Omega$	$t_{d(off)}$	-	25	40	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 31 \text{ A}$ $R_G = 13 \Omega$	t_f	-	20	30	
Gate charge at threshold $V_{DD} = 40 \text{ V}$, $I_D = 0.1 \text{ A}$, $V_{GS} = 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	0.7	1	nC
Gate charge at 7.0 V $V_{DD} = 40 \text{ V}$, $I_D = 31 \text{ A}$, $V_{GS} = 0 \text{ to } 7 \text{ V}$	$Q_{g(7)}$	-	20	30	
Gate charge total $V_{DD} = 40 \text{ V}$, $I_D = 31 \text{ A}$, $V_{GS} = 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	25	40	
Gate plateau voltage $V_{DD} = 40 \text{ V}$, $I_D = 31 \text{ A}$	$V_{(plateau)}$	-	5.9	-	V

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

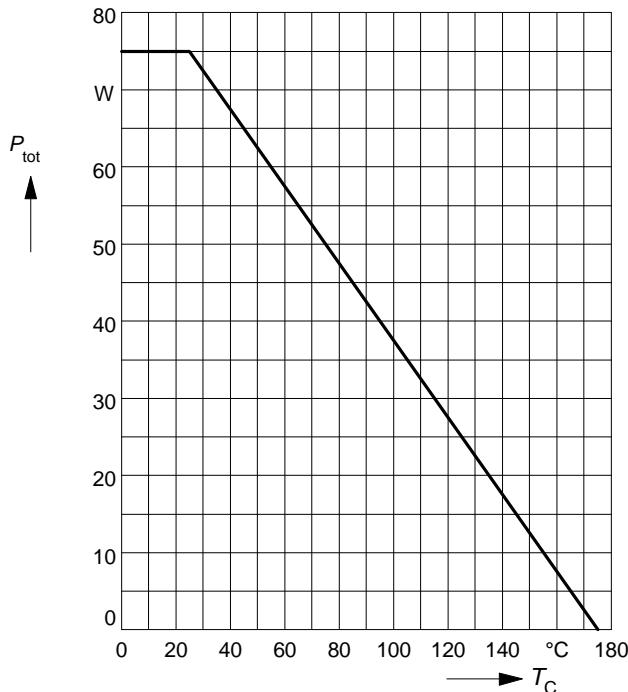
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	I_S	-	-	31	A
Inverse diode direct current,pulsed $T_C = 25^\circ\text{C}$	I_{SM}	-	-	124	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 62 \text{ A}$	V_{SD}	-	1.2	1.8	V
Reverse recovery time $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	t_{rr}	-	55	85	ns
Reverse recovery charge $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	Q_{rr}	-	0.1	0.15	μC

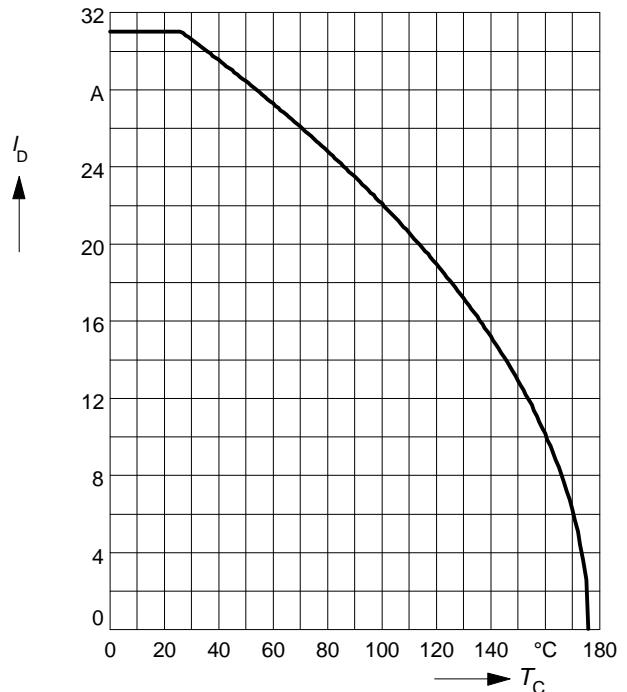
Power dissipation

$$P_{\text{tot}} = f(T_C)$$


Drain current

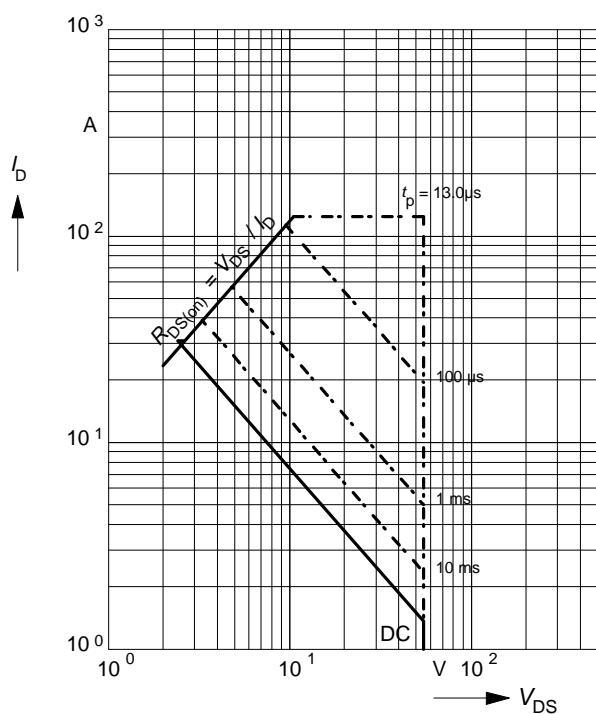
$$I_D = f(T_C)$$

parameter: $V_{GS} \geq 10$ V


Safe operating area

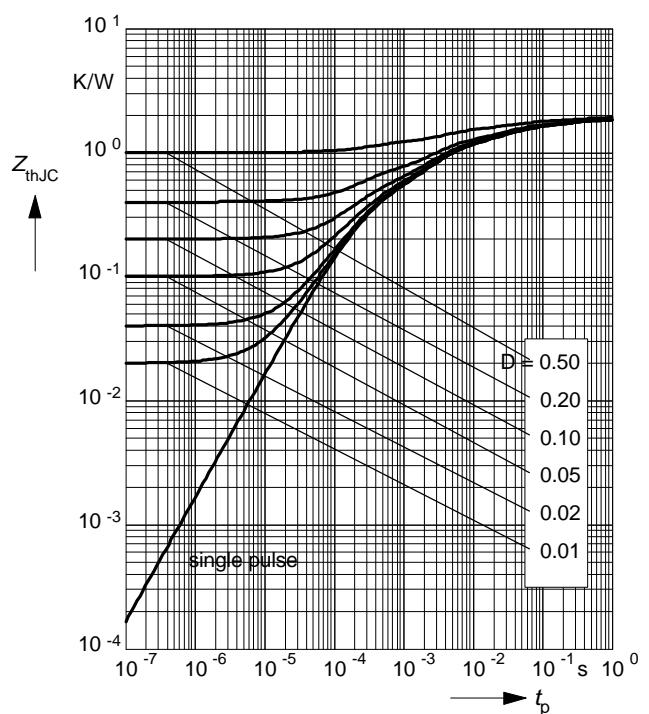
$$I_D = f(V_{DS})$$

parameter: $D = 0$, $T_C = 25^\circ\text{C}$


Transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

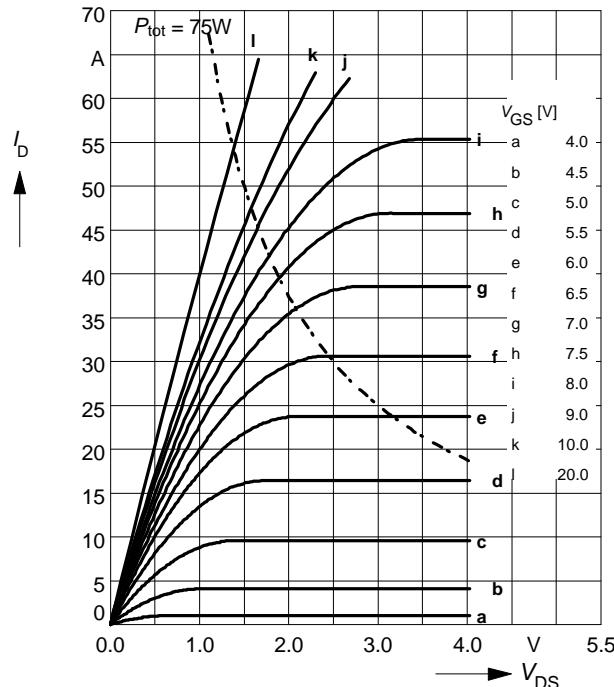
parameter: $D = t_p / T$



Typ. output characteristics

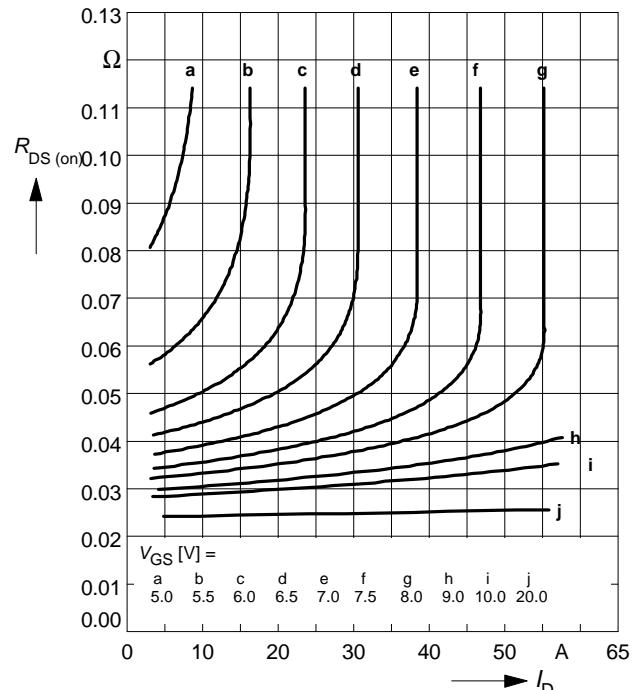
$$I_D = f(V_{DS})$$

parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$


Typ. drain-source on-resistance

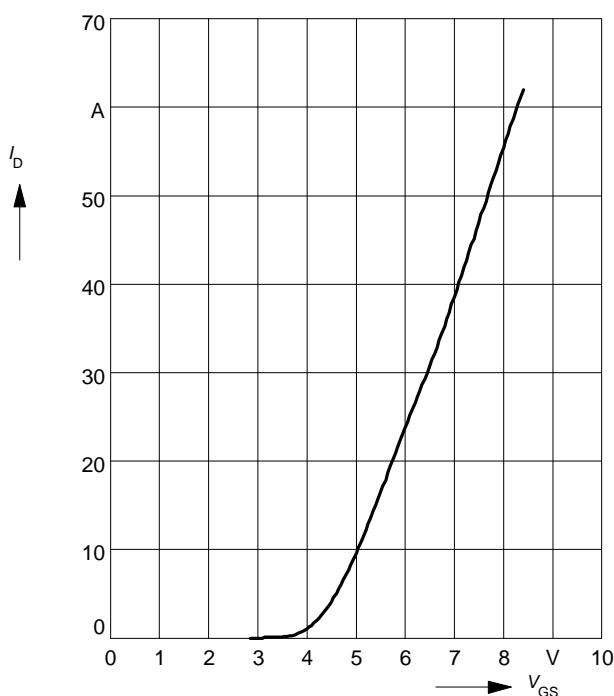
$$R_{DS(on)} = f(I_D)$$

parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$


Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu\text{s}$

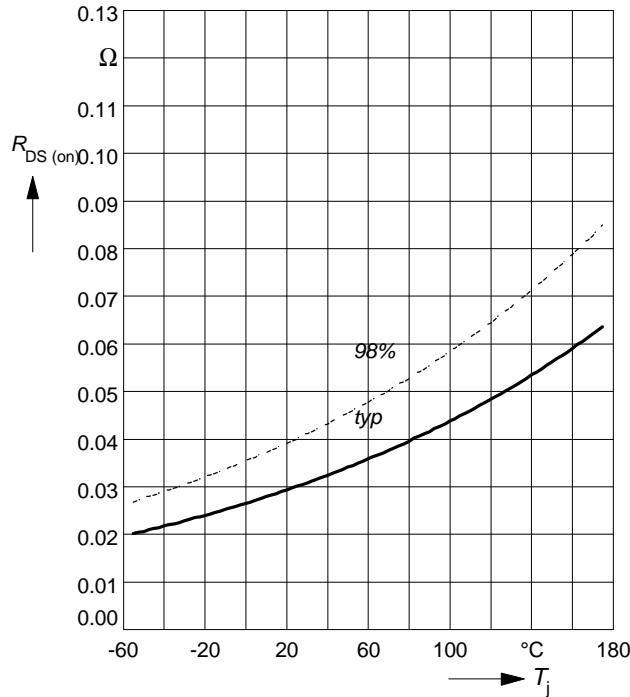
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)\max}$$



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

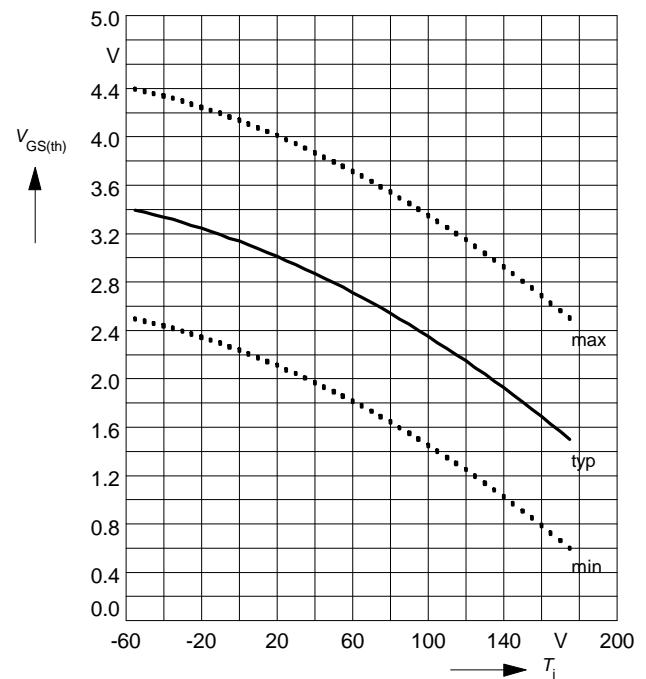
parameter: $I_D = 22 \text{ A}$, $V_{GS} = 10 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

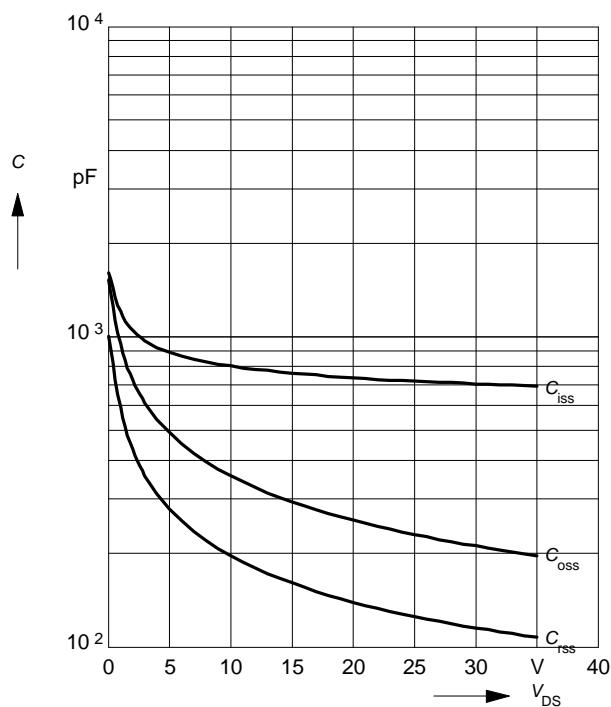
parameter: $V_{GS} = V_{DS}$, $I_D = 50 \mu\text{A}$



Typ. capacitances

$$C = f(V_{DS})$$

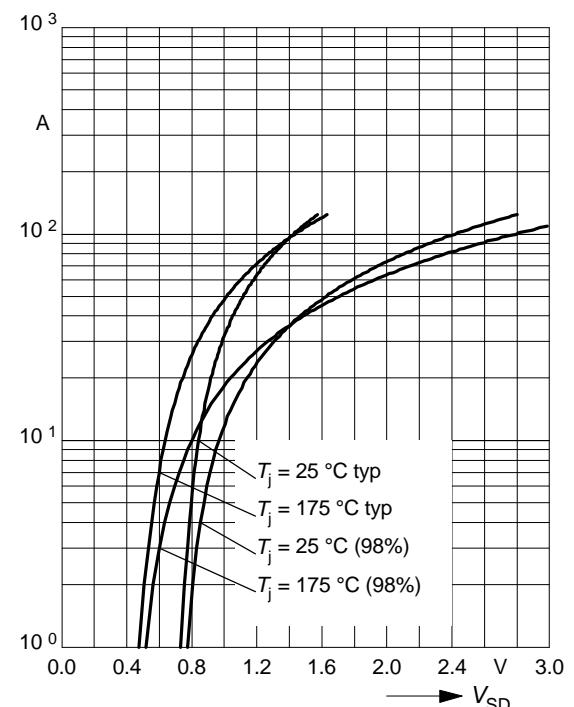
parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



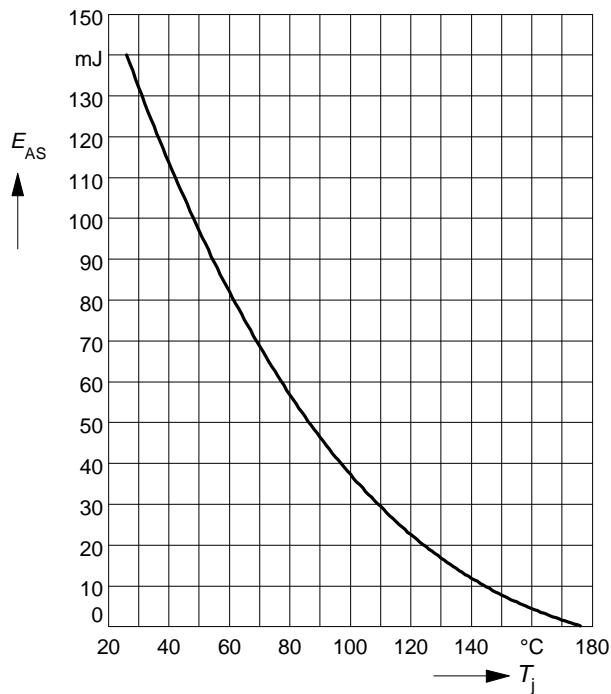
Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

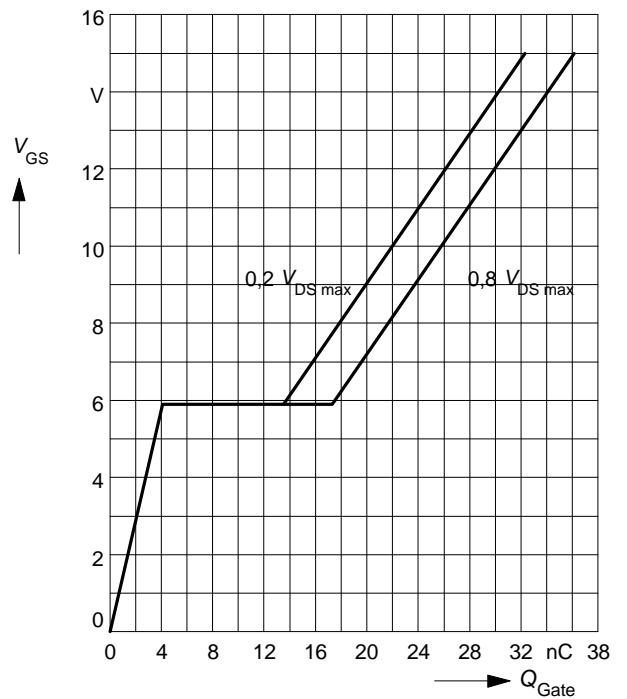
parameter: T_j , $t_p = 80 \mu\text{s}$



Avalanche energy $E_{AS} = f(T_j)$
 parameter: $I_D = 31 \text{ A}$, $V_{DD} = 25 \text{ V}$
 $R_{GS} = 25 \Omega$, $L = 291 \mu\text{H}$



Typ. gate charge
 $V_{GS} = f(Q_{Gate})$
 parameter: $I_D \text{ puls} = 31 \text{ A}$



Drain-source breakdown voltage
 $V_{(BR)DSS} = f(T_j)$

